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Texas Instruments SN74AVCA164245KR

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> 16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

> > SCES395B-JULY 2002-REVISED OCTOBER 2005

SN74AVCA164245

#### FEATURES

STRUMENTS

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- Member of the Texas Instruments Widebus™ Family
- DOC<sup>™</sup> Circuitry Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With I<sub>OH</sub> and I<sub>OL</sub> of  $\pm$ 24 mA at 2.5-V V<sub>CC</sub>
- Control Inputs V<sub>IH</sub>/V<sub>IL</sub> Levels Are Referenced to V<sub>CCA</sub> Voltage
- If Either V<sub>CC</sub> Input Is at GND, Both Ports Are in the High-Impedance State

- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.4-V to 3.6-V Power-Supply Range
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

#### **DESCRIPTION/ORDERING INFORMATION**

This 16-bit (dual-octal) noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$ .  $V_{CCA}$  accepts any supply voltage from 1.4 V to 3.6 V. The B port is designed to track  $V_{CCB}$ .  $V_{CCB}$  accepts any supply voltage from 1.4 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCA164245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable  $(\overline{OE})$  input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCA164245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V<sub>CCA</sub>.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CCA</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. If either  $V_{CC}$  input is at GND, then both ports are in the high-impedance state.

T <sub>A</sub>	PACKA	GE <sup>(1)</sup>	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	TSSOP – DGG	Tape and reel	SN74AVCA164245GR	AVCA164245	
40°C to 95°C	TVSOP – DGV	Tape and reel	SN74AVCA164245VR	WA4245	
–40°C to 85°C	VFBGA – GQL	Tape and reel	SN74AVCA164245KR	10/0 40 45	
	VFBGA – ZQL	Tape and reel	74AVCA164245ZQLR	- WA4245	

#### **ORDERING INFORMATION**

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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#### **TERMINAL ASSIGNMENTS**

#### GQL OR ZQL PACKAGE (TOP VIEW) 1 2 3 4 5 6 000000 Α 000000 в 000000 С 000000 D $\bigcirc \bigcirc$ $\bigcirc \bigcirc$ Е OO $\bigcirc \bigcirc$ F 000000 G 000000 н 000000 J 000000 κ

#### **TERMINAL ASSIGNMENTS(1)**

	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 <del>0E</del>
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V <sub>CCB</sub>	V <sub>CCA</sub>	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
Е	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
н	2B5	2B6	V <sub>CCB</sub>	V <sub>CCA</sub>	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
К	2DIR	NC	NC	NC	NC	2 <mark>0E</mark>

(1) NC - No internal connection





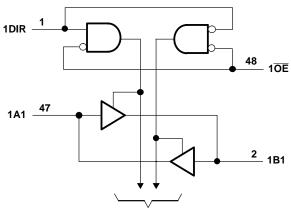
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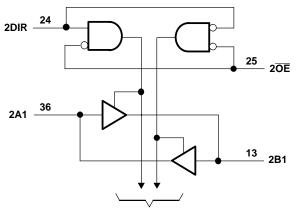
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#### FUNCTION TABLE (EACH 8-BIT SECTION)

INP	UTS	OPERATION
ŌĒ	DIR	OPERATION
L	L	B data to A bus
L	н	A data to B bus
н	Х	Isolation

#### LOGIC DIAGRAM (POSITIVE LOGIC)





**To Seven Other Channels** 

To Seven Other Channels

Pin numbers shown are for the DGG and DGV packages.



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#### Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V <sub>CCA</sub> V <sub>CCB</sub>	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
VI	Input voltage range <sup>(2)</sup>	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output	A port	-0.5	4.6	V
Vo	in the high-impedance or power-off state <sup>(2)</sup>	B port	-0.5	4.6	v
M	$\lambda$ (alternative complicity of a new system) in the birth and $(2)/(3)$	A port	-0.5 V	<sub>CCA</sub> + 0.5	V
Vo	Voltage range applied to any output in the high or low state $^{(2)(3)}$	B port	-0.5 V <sub>0</sub>	<sub>ССВ</sub> + 0.5	v
I <sub>IK</sub>	Input clamp current	V <sub>1</sub> < 0		-50	mA
I <sub>OK</sub>	Output clamp current	V <sub>0</sub> < 0		-50	mA
I <sub>O</sub>	Continuous output current			±50	mA
	Continuous current through V <sub>CCA</sub> , V <sub>CCB</sub> , or GND			±100	mA
		DGG package		70	
$\theta_{JA}$	Package thermal impedance <sup>(4)</sup>	DGV package		58	°C/W
		GQL/ZQL package		42	
T <sub>stg</sub>	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed. (2)

(3) (4) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

The package thermal impedance is calculated in accordance with JESD 51-7.





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# Recommended Operating Conditions<sup>(1)(2)(3)</sup>

			V <sub>CCI</sub>	V <sub>cco</sub>	MIN	MAX	UNIT
V <sub>CCA</sub>	Supply voltage				1.4	3.6	V
V <sub>CCB</sub>	Supply voltage				1.4	3.6	V
			1.4 V to 1.95 V		$V_{CCI}  imes 0.65$		
V <sub>IH</sub>	High-level input voltage	Data inputs	1.95 V to 2.7 V		1.7		V
	input voltage		2.7 V to 3.6 V		2		
			1.4 V to 1.95 V			$V_{CCI}  imes 0.35$	
V <sub>IL</sub>	Low-level input voltage	Data inputs	1.95 V to 2.7 V			0.7	V
	input voltage		2.7 V to 3.6 V			0.8	
			1.4 V to 1.95 V		$V_{CCA}  imes 0.65$		
V <sub>IH</sub>	High-level input voltage	Control inputs (referenced to V <sub>CCA</sub> )	1.95 V to 2.7 V		1.7		V
	input voltage		2.7 V to 3.6 V		2		
			1.4 V to 1.95 V			$V_{CCA}  imes 0.35$	
V <sub>IL</sub>	Low-level input voltage	1 46 V to 2 / V		0.7	V		
	input voltage		2.7 V to 3.6 V			0.8	
VI	Input voltage				0	3.6	V
M	Outrast such as	Active state			0	V <sub>CCO</sub>	V
Vo	Output voltage	3-state			0	3.6	V
				1.4 V to 1.6 V		-2	
				1.65 V to 1.95 V		-4	
I <sub>ОН</sub>	High-level output cu	Irrent		2.3 V to 2.7 V		-8	mA
				3 V to 3.6 V		-12	
				1.4 V to 1.6 V		2	
				1.65 V to 1.95 V		4	
I <sub>OL</sub>	Low-level output cu	rrent		2.3 V to 2.7 V		8	mA
				3 V to 3.6 V		12	
$\Delta t / \Delta v$	Input transition rise	or fall rate				5	ns/V
T <sub>A</sub>	Operating free-air te	emperature			-40	85	°C

(1)

(2) (3)

 $V_{CCI}$  is the  $V_{CC}$  associated with the input port.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port. All unused data inputs of the device must be held at  $V_{CCI}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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### Electrical Characteristics<sup>(1)(2)</sup>

over recommended operating free-air temperature range (unless otherwise noted)

PA	RAMETER	TEST CON	IDITIONS	V <sub>CCA</sub>	V <sub>CCB</sub>	ΜΙΝ ΤΥ	(P <sup>(3)</sup> MAX	UNIT
		I <sub>OH</sub> = −100 μA,	$V_I = V_{IH}$	1.4 V to 3.6 V	1.4 V to 3.6 V	V <sub>CCO</sub> – 0.2		
		$I_{OH} = -2 \text{ mA},$	$V_{I} = V_{IH}$	1.4 V	1.4 V	1.05		
V <sub>он</sub>		$I_{OH} = -4 \text{ mA},$	$V_{I} = V_{IH}$	1.65 V	1.65 V	1.2		V
		I <sub>OH</sub> = -8 mA,	$V_{I} = V_{IH}$	2.3 V	2.3 V	1.75		
		I <sub>OH</sub> = -12 mA,	$V_{I} = V_{IH}$	3 V	3 V	2.3		
		I <sub>OH</sub> = 100 μA,	$V_{I} = V_{IL}$	1.4 V to 3.6 V	1.4 V to 3.6 V		0.2	
		$I_{OH} = 2 \text{ mA},$	$V_{I} = V_{IL}$	1.4 V	1.4 V		0.35	
V <sub>OL</sub>		$I_{OH} = 4 \text{ mA},$	$V_{I} = V_{IL}$	1.65 V	1.65 V		0.45	V
		I <sub>OH</sub> = 8 mA,	$V_{I} = V_{IL}$	2.3 V	2.3 V		0.55	
		I <sub>OH</sub> = 12 mA,	$V_{I} = V_{IL}$	3 V	3 V		0.7	
I,	Control inputs	$V_I = V_{CCA}$ or GND		1.4 V to 3.6 V	3.6 V		±2.5	μA
	A port	$-V_1 \text{ or } V_0 = 0 \text{ to } 3.6 \text{ V}$		0 V	0 to 3.6 V		±10	μA
off	B port	$v_1 \text{ or } v_0 = 0 \text{ to } 3.6 \text{ v}$		0 to 3.6 V	0 V		±10	μА
	A or B port		$\overline{OE} = V_{IH}$	3.6 V	3.6 V		±12.5	
oz <sup>(4)</sup>	B port	$V_0 = V_{CCO} \text{ or GND},$ $V_1 = V_{1H} \text{ or } V_{1L}$	OE = don't care	0 V	3.6 V		±12.5	μΑ
	A port	·   ·  H •· ·  L		3.6 V	0 V		±12.5	
				1.6 V	1.6 V		20	
				1.95 V	1.95 V		20	
		V <sub>I</sub> = V <sub>CCI</sub> or GND,	L. – 0	2.7 V	2.7 V		30	μA
CCA		$v_{\rm I} = v_{\rm CCI}  or  Or  O,$	10 = 0	0 V	3.6 V		-40	μΑ
				3.6 V	0 V		40	
				3.6 V	3.6 V		40	
				1.6 V	1.6 V		20	
				1.95 V	1.95 V		20	
		V <sub>I</sub> = V <sub>CCI</sub> or GND,	L. – 0	2.7 V	2.7 V		30	μA
ССВ			-0 - 0	0 V	3.6 V		40	μΛ
				3.6 V	0 V		-40	
	1			3.6 V	3.6 V		40	
Ci	Control inputs	$V_{I} = 3.3 \text{ V or GND}$		3.3 V	3.3 V		4	pF
C <sub>io</sub>	A or B port	$V_0 = 3.3 \text{ V or GND}$		3.3 V	3.3 V		5	pF

 $V_{CCO}$  is the  $V_{CC}$  associated with the output port.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port. All typical values are at  $T_A=25^\circ C.$ (1)

(2) (3)

(4) For 1/O ports, the parameter  $I_{OZ}$  includes the input leakage current.





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#### **Switching Characteristics**

over recommended operating free-air temperature range, V\_{CCA} = 1.5 V  $\pm$  0.1 V (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = ± 0.1	V <sub>CCB</sub> = 1.5 V ± 0.1 V		V <sub>CCB</sub> = 1.8 V ± 0.15 V		V <sub>CCB</sub> = 2.5 V ± 0.2 V		V <sub>CCB</sub> = 3.3 V ± 0.3 V	
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	A	В	1.7	6.7	1.9	6.3	1.8	5.5	1.7	5.8	20
Lpd	В	А	1.8	6.8	2.2	7.4	2.1	7.6	2.1	7.3	ns
	OE	А	2.6	8.4	2.7	8.2	2.3	6.3	2.1	5.6	20
t <sub>en</sub>	OE	В	2.7	8.6	3.2	10.2	3.2	10.8	3.2	10.7	ns
+	OE	A	2.1	7	2.5	7	1.7	5.3	2	6.1	
t <sub>dis</sub>	UE	В	2.1	7.1	2.5	7.1	2.1	6.5	2.1	6.4	ns

#### **Switching Characteristics**

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.8 V  $\pm$  0.15 V (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>ССВ</sub> = ± 0.1	V <sub>CCB</sub> = 1.5 V ± 0.1 V		V <sub>CCB</sub> = 1.8 V ± 0.15 V		2.5 V 2 V	V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT
	(INPUT)	(001201)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	A	В	1.7	6.4	1.8	6	1.7	4.7	1.6	4.3	
t <sub>pd</sub>	В	A	1.4	5.5	1.8	6	1.8	5.8	1.8	5.5	ns
	OE	A	2.5	8	2.7	7.8	2.2	5.8	2	5.1	3
t <sub>en</sub>	UE	В	1.8	6.7	2.7	7.8	2.7	8.1	2.7	8.1	ns
	OE	A	2.1	6.4	2.5	6.4	1.5	4.5	1.8	5	3
t <sub>dis</sub>	UE	В	2.1	6.6	2.5	6.4	2	5.5	2	5.5	ns

#### **Switching Characteristics**

over recommended operating free-air temperature range, V\_{CCA} = 2.5 V  $\pm$  0.2 V (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = ± 0.1	V <sub>CCB</sub> = 1.5 V ± 0.1 V		$V_{CCB}$ = 1.8 V ± 0.15 V		2.5 V 2 V	V <sub>CCB</sub> = 3.3 V ± 0.3 V		UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	А	В	1.6	6	1.8	5.6	1.5	4	1.4	3.4	2
<sup>L</sup> pd	В	A	1.3	4.6	1.7	4.4	1.5	4	1.4	3.7	ns
		A	2.6	7.4	2.7	7.2	2.2	5.3	2	4.5	5
t <sub>en</sub> OE	UE	В	1.2	4.1	2.2	5.1	2.2	5.3	2.2	5.3	ns
	OE	A	2	5.7	2.3	5.7	1.4	3.7	1.6	4	
t <sub>dis</sub>	ÛE	В	0.9	4.5	1.7	4.5	1.4	3.7	1.4	3.7	ns



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#### **Switching Characteristics**

over recommended operating free-air temperature range, V<sub>CCA</sub> = 3.3 V  $\pm$  0.3 V (see Figure 2)

PARAMETER	FROM	TO	V <sub>CCB</sub> = ± 0.1	V <sub>CCB</sub> = 1.5 V ± 0.1 V		V <sub>CCB</sub> = 1.8 V ± 0.15 V		V <sub>CCB</sub> = 2.5 V ± 0.2 V		V <sub>CCB</sub> = 3.3 V ± 0.3 V	
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
	A	В	1.5	5.9	1.7	5.4	1.5	3.7	1.4	3.1	20
lpd	В	А	1.3	4.5	1.6	3.8	1.5	3.3	1.4	3.1	ns
	OE	А	2.5	7	2.6	6.9	2.1	5	1.9	4.1	20
t <sub>en</sub>	UE	В	0.8	2.6	1.9	4	2	4.1	1.9	4.1	ns
. 7	OE	А	1.2	5.4	2.2	5.2	1.2	3.3	1.5	3.6	
t <sub>dis</sub>	UE	В	1.2	5.4	1.7	4.4	1.5	3.6	1.5	3.6	ns

#### **Operating Characteristics**

 $V_{CCA}$  and  $V_{CCB}$  = 3.3 V,  $T_A$  = 25°C

	PARAMETER		TEST C	ONDITIONS	TYP	UNIT
	Power dissipation capacitance per transceiver,	Outputs enabled			14	
<u> </u>	A-port input, B-port output	Outputs disabled		f = 10 MHz	7	рF
C <sub>pdA</sub>	Power dissipation capacitance per transceiver,	Outputs enabled	$-C_{L} = 0,$		20	рг
	B-port input, A-port output	Outputs disabled			7	
	Power dissipation capacitance per transceiver,	Outputs enabled			14	
0	A-port input, B-port output	Outputs disabled			7	pF
C <sub>pdB</sub>	Power dissipation capacitance per transceiver,	Outputs enabled	$-C_{L} = 0,$	f = 10 MHz	20	
	B-port input, A-port output	Outputs disabled			7	

#### **OUTPUT DESCRIPTION**

The DOC<sup>TM</sup> circuitry is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical  $V_{OL}$  vs  $I_{OL}$  and  $V_{OH}$  vs  $I_{OH}$  curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA006, and *Dynamic Output Control (DOC<sup>TM</sup>) Circuitry Technology and Applications*, literature number SCEA009.

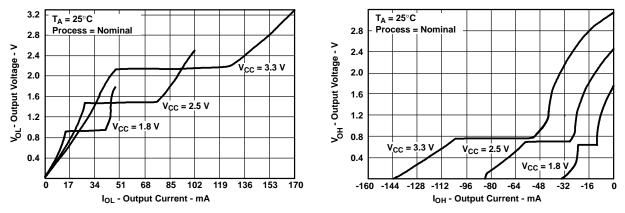


Figure 1. Output Voltage vs Output Current



TEXAS

- ij

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INSTRUMENTS WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS www.ti.com SCES395B-JULY 2002-REVISED OCTOBER 2005 PARAMETER MEASUREMENT INFORMATION  $2 \times V_{CCO}$ 0 TEST **S**1 **S1**  $R_L$ O Open Open t<sub>pd</sub> From Output t<sub>PLZ</sub>/t<sub>PZL</sub>  $2 \times V_{CCO}$ GND Under Test GND t<sub>PHZ</sub>/t<sub>PZH</sub> С  $R_L$ ξ (see Note A) 1 LOAD CIRCUIT V<sub>CCI</sub> V<sub>CCI</sub>/2 V<sub>CCI</sub>/2 Input V<sub>CCO</sub>  $C_L$ RL VTP 0 V  $\textbf{1.5 V} \pm \textbf{0.1 V}$ **2 k**Ω 0.1 V 15 pF **VOLTAGE WAVEFORMS** 30 pF 0.15 V 1.8 V ± 0.15 V **1 k**Ω PULSE DURATION 30 pF **500** Ω 0.15 V  $\textbf{2.5 V} \pm \textbf{0.2 V}$  $\textbf{3.3 V} \pm \textbf{0.3 V}$ 30 pF **500** Ω 0.3 V V<sub>CCB</sub> Output Control V<sub>CCB</sub>/2 V<sub>ССВ</sub>/2 (low-level enabling) 0 V t<sub>PLZ</sub> t<sub>PZL</sub> Vcco Output V<sub>CCI</sub> V<sub>CCO</sub>/2 Waveform 1 Input V<sub>CCI</sub>/2 V<sub>CCI</sub>/2 VOL + VTP S1 at  $2 \times V_{CCO}$ VoL 0 V (see Note B) t<sub>PHZ</sub> t<sub>P7H</sub> · t<sub>PLH</sub> t<sub>PHL</sub> Output VoH Waveform 2 VOH VOH - VTP cco/2 S1 at GND Output V<sub>CCO</sub>/2 V<sub>CCO</sub>/2 (see Note B) 0 V

#### VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES

VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES

SN74AVCA164245

**16-BIT DUAL-SUPPLY BUS TRANSCEIVER** 

NOTES: A.  $C_L$  includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>Q</sub> = 50 Ω, dv/dt ≥ 1 V/ns.

VoL

- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- I.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

#### Figure 2. Load Circuit and Voltage Waveforms



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#### PACKAGING INFORMATION

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Orderable Device		Package Type	Package Drawing			Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
74AVCA164245GRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCA164245	Sample
74AVCA164245GRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCA164245	Sample
74AVCA164245VRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	WA4245	Sample
74AVCA164245ZQLR	ACTIVE	BGA MICROSTAR JUNIOR	ZQL	56	1000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	WA4245	Sample
SN74AVCA164245GR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVCA164245	Sample
SN74AVCA164245KR	OBSOLETE	BGA MICROSTAR JUNIOR	GQL	56		TBD	Call TI	Call TI	-40 to 85	WA4245	
SN74AVCA164245VR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	WA4245	Sample

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

ILFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that the current of the two states are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS Exempt):

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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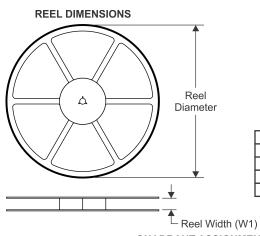
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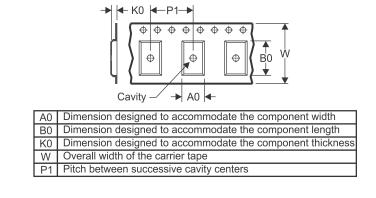


# PACKAGE MATERIALS INFORMATION

3-Aug-2013

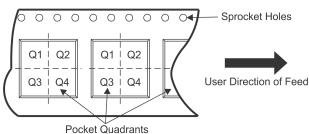
### TAPE AND REEL INFORMATION





TAPE DIMENSIONS

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
74AVCA164245ZQLR	BGA MI CROSTA R JUNI OR	ZQL	56	1000	330.0	16.4	4.8	7.3	1.5	8.0	16.0	Q1
SN74AVCA164245GR	TSSOP	DGG	48	2000	330.0	24.4	8.6	15.8	1.8	12.0	24.0	Q1
SN74AVCA164245VR	TVSOP	DGV	48	2000	330.0	16.4	7.1	10.2	1.6	12.0	16.0	Q1



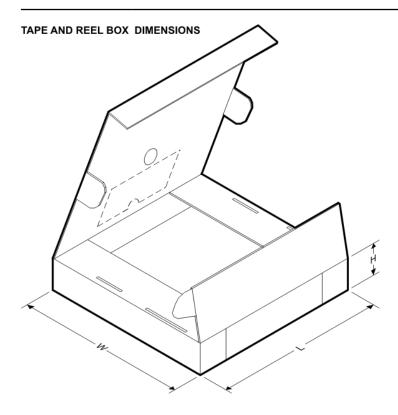
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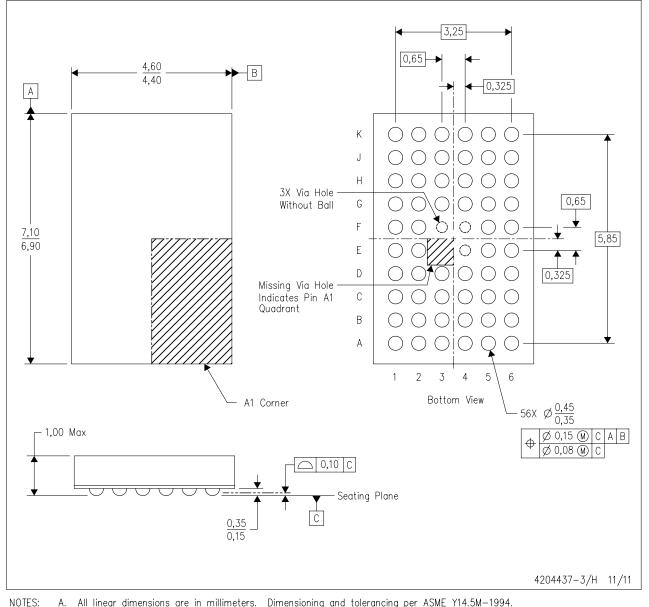
\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
74AVCA164245ZQLR	BGA MICROSTAR JUNIOR	ZQL	56	1000	336.6	336.6	28.6
SN74AVCA164245GR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74AVCA164245VR	TVSOP	DGV	48	2000	367.0	367.0	38.0



ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY



All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994. Α.

- Β. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is Pb-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

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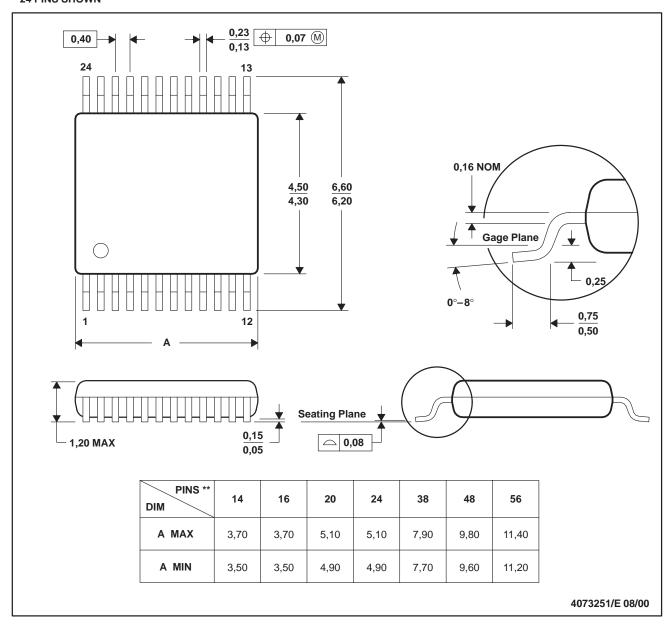




MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

#### PLASTIC SMALL-OUTLINE

DGV (R-PDSO-G\*\*) 24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins - MO-153

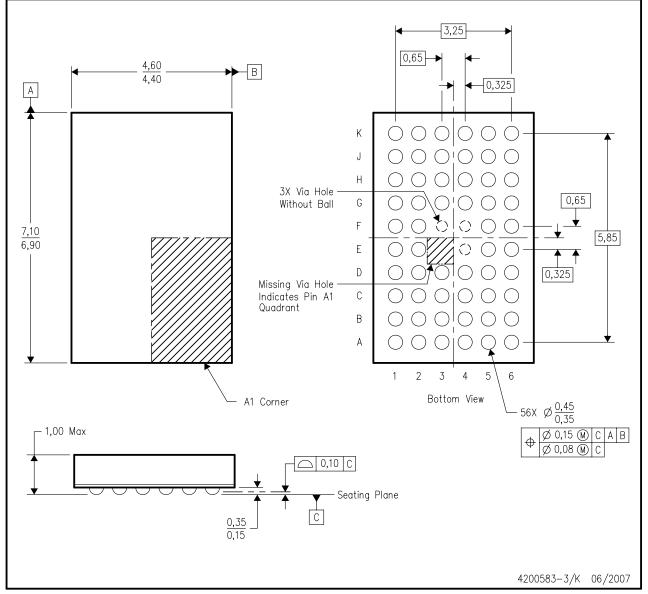
14/16/20/56 Pins – MO-194





# GQL (R-PBGA-N56)

# PLASTIC BALL GRID ARRAY



NOTES:

- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MO-285 variation BA-2.
- D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.



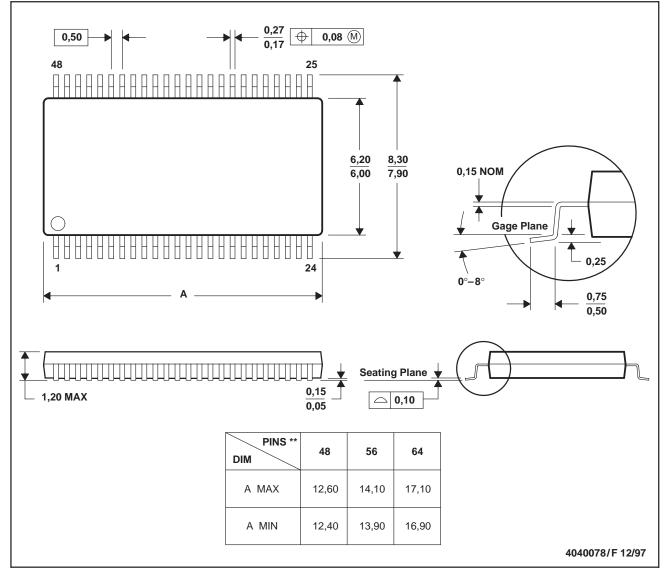


MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

# DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153





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